

ABSOLUTE MAXIMUM RATINGS				
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT
INPUT				
Peak reverse voltage		$V_R$	6	V
Forward continuous current		$I_F$	60	mA
Power dissipation		$P_{diss}$	90	mW
Derate linearly from 25 °C			1.2	mW/°C
OUTPUT				
Collector emitter breakdown voltage		$BV_{CEO}$	70	V
Emitter collector breakdown voltage		$BV_{ECO}$	7	V
Collector-base breakdown voltage		$BV_{CBO}$	70	V
$I_{C_{MAX}}$ DC		$I_{C_{MAX}}$ DC	50	mA
$I_{C_{MAX}}$	$t < 1$ ms	$I_{C_{MAX}}$	100	mA
Power dissipation		$P_{diss}$	150	mW
Derate linearly from 25 °C			2	mW/°C
COUPLER				
Isolation test voltage		$V_{ISO}$	4000	$V_{RMS}$
Total package dissipation (LED and detector)		$P_{tot}$	240	mW
Derate linearly from 25 °C			3.3	mW/°C
Operating temperature		$T_{amb}$	- 55 to + 100	°C
Storage temperature		$T_{stg}$	- 55 to + 150	°C
Soldering time	at 260 °C		10	s

## Note

$T_{amb} = 25$  °C, unless otherwise specified.

Stresses in excess of the absolute maximum ratings can cause permanent damage to the device. Functional operation of the device is not implied at these or any other conditions in excess of those given in the operational sections of this document. Exposure to absolute maximum ratings for extended periods of the time can adversely affect reliability.

ELECTRICAL CHARACTERISTICS							
PARAMETER	TEST CONDITION	PART	SYMBOL	MIN.	TYP.	MAX.	UNIT
INPUT							
Forward voltage	$I_F = 10$ mA		$V_F$		1.3	1.5	V
Reverse current	$V_R = 6$ V		$I_R$		0.1	100	μA
Capacitance	$V_R = 0$ V		$C_O$		13		pF
OUTPUT							
Collector emitter breakdown voltage	$I_C = 100$ μA		$BV_{CEO}$	70			V
Emitter collector breakdown voltage	$I_E = 100$ μA		$BV_{ECO}$	7	10		V
Collector emitter leakage current	$V_{CE} = 10$ V		$I_{CEO}$		5	50	nA
COUPLER							
Saturation voltage, collector emitter	$I_C = 2$ mA, $I_F = 10$ mA		$V_{CEsat}$			0.4	V
Capacitance, input to output			$C_{IO}$		0.5		pF
Resistance, input to output			$R_{IO}$		100		GΩ

## Note

$T_{amb} = 25$  °C, unless otherwise specified.

Minimum and maximum values were tested requirements. Typical values are characteristics of the device and are the result of engineering evaluations. Typical values are for information only and are not part of the testing requirements.



## IL205AT/206AT/207AT/208AT

Optocoupler, Phototransistor Output, Vishay Semiconductors  
with Base Connection in SOIC-8 Package

### CURRENT TRANSFER RATIO

PARAMETER	TEST CONDITION	PART	SYMBOL	MIN.	TYP.	MAX.	UNIT
Current transfer ratio	$I_F = 10 \text{ mA}$ , $V_{CE} = 5 \text{ V}$	IL205AT	CTR	40		80	%
		IL206AT	CTR	63		125	%
		IL207AT	CTR	100		200	%
		IL208AT	CTR	100		320	%
	$I_F = 1 \text{ mA}$ , $V_{CE} = 5 \text{ V}$	IL205AT	CTR	13	25		%
		IL206AT	CTR	22	40		%
		IL207AT	CTR	34	60		%
		IL208AT	CTR	56	95		%

### SWITCHING CHARACTERISTICS

PARAMETER	TEST CONDITION	PART	SYMBOL	MIN.	TYP.	MAX.	UNIT
Switching time	$I_C = 2 \text{ mA}$ , $R_L = 100 \Omega$ , $V_{CC} = 10 \text{ V}$		$t_{on}$ , $t_{off}$		3		$\mu\text{s}$

### SAFETY AND INSULATION RATINGS

PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
Climatic classification (according to IEC 68 part 1)				55/100/21		
Comparative tracking index		CTI	175		399	
$V_{IOTM}$			6000			V
$V_{IORM}$			560			V
$P_{SO}$					350	mW
$I_{SI}$					150	mA
$T_{SI}$					165	°C
Creepage			4			mm
Clearance			4			mm
Insulation thickness, reinforced rated	per IEC 60950 2.10.5.1		0.2			mm

#### Note

As per IEC 60747-5-2, §7.4.3.8.1, this optocoupler is suitable for “safe electrical insulation” only within the safety ratings. Compliance with the safety ratings shall be ensured by means of protective circuits.

## TYPICAL CHARACTERISTICS

$T_{amb} = 25\text{ }^{\circ}\text{C}$ , unless otherwise specified

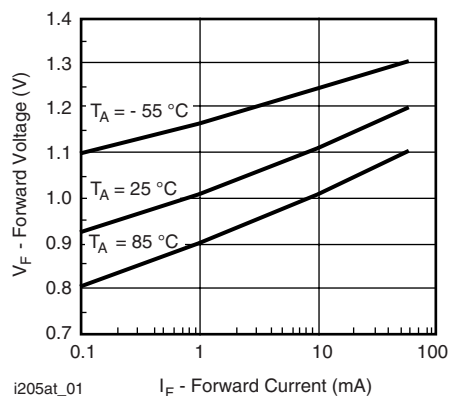


Fig. 1 - Forward Voltage vs. Forward Current

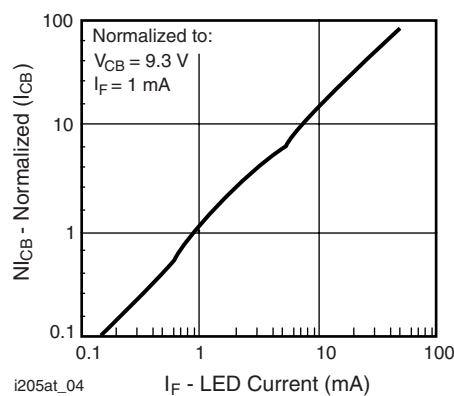


Fig. 4 - Normalized Collector-Base Photocurrent vs. LED Current

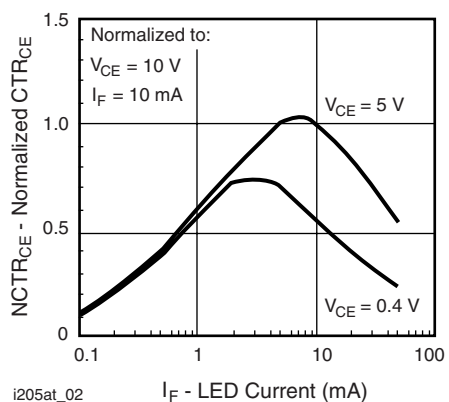


Fig. 2 - Normalized Non-Saturated and Saturated  $CTR_{CE}$  vs. LED Current

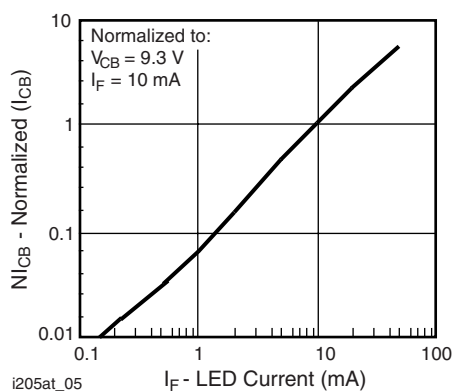


Fig. 5 - Normalized Collector-Base Photocurrent vs. LED Current

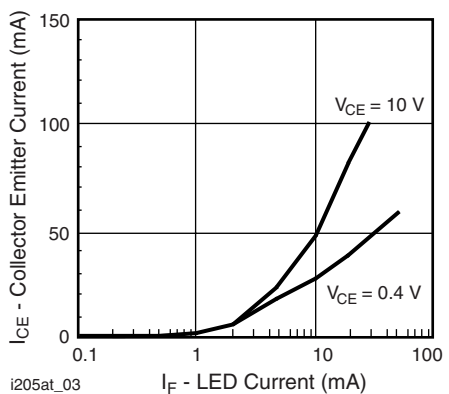


Fig. 3 - Collector Emitter Current vs. LED Current

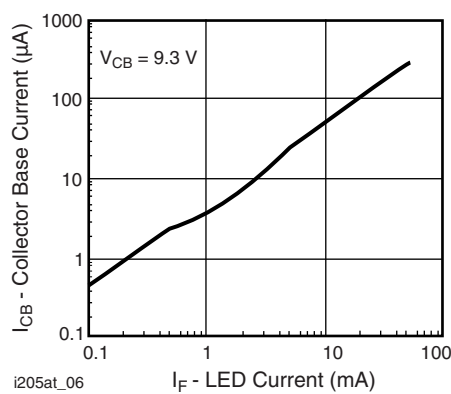


Fig. 6 - Collector Emitter Photocurrent vs. LED Current

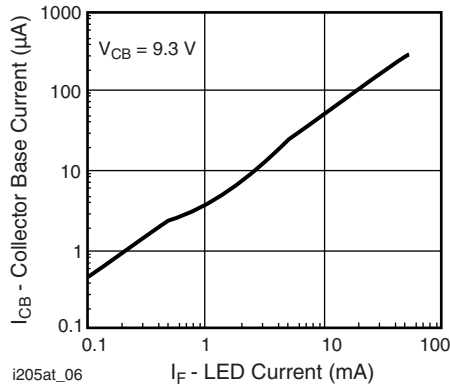


Fig. 7 - Collector Emitter Photocurrent vs. LED Current

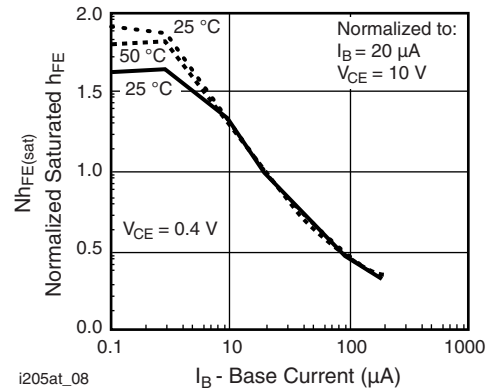


Fig. 9 - Typical Switching Characteristics vs. Base Resistance (Saturated Operation)

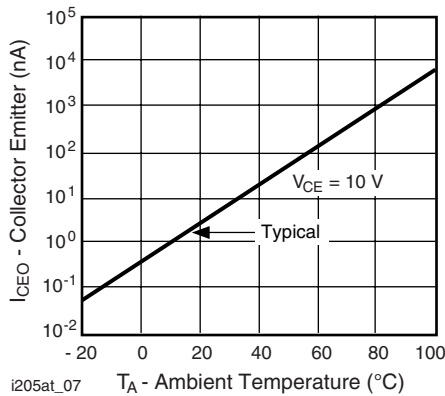


Fig. 8 - Base Current vs.  $I_F$  and  $h_{FE}$

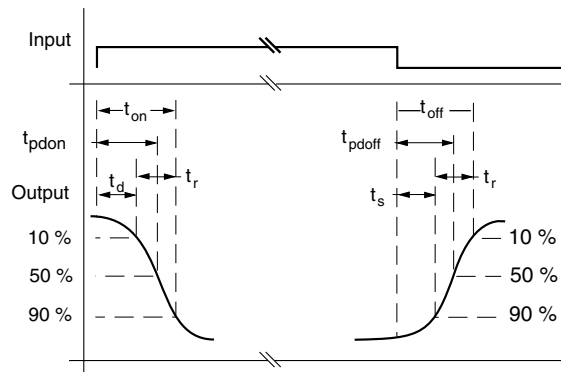
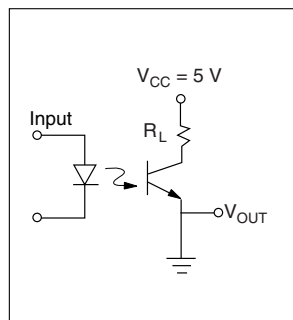


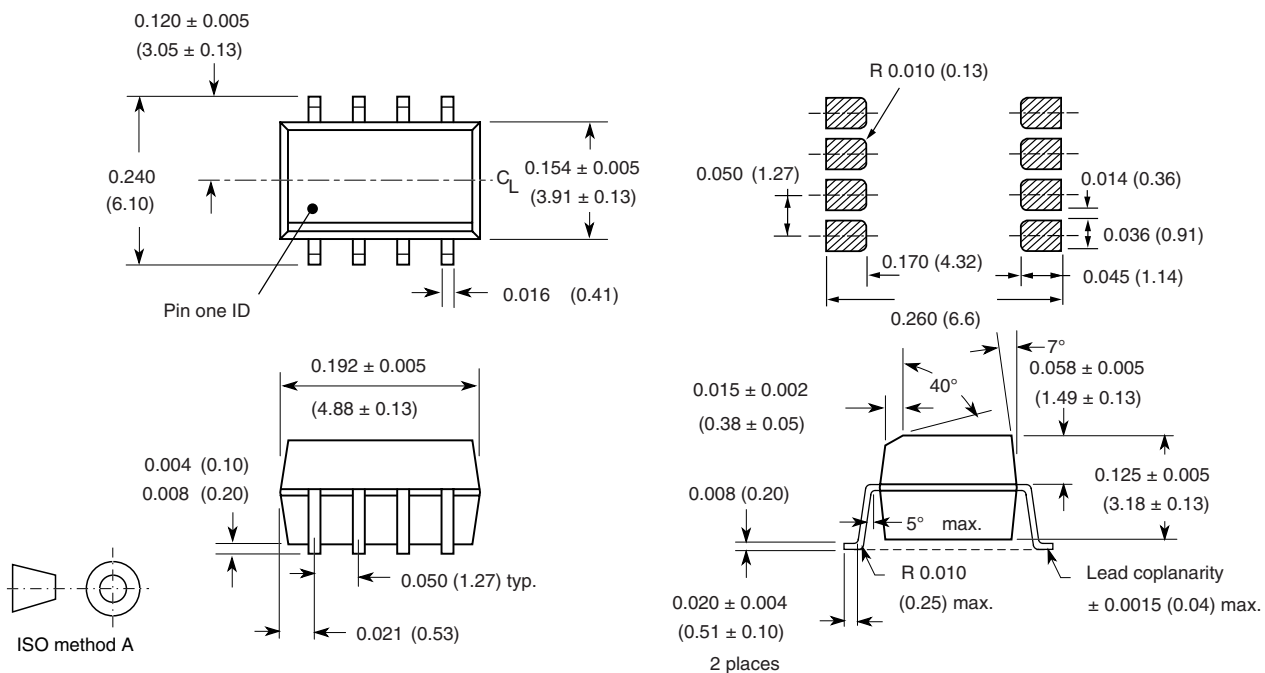
Fig. 10 Switching Test Circuit

# IL205AT/206AT/207AT/208AT

Vishay Semiconductors Optocoupler, Phototransistor Output,  
with Base Connection in SOIC-8 Package



## PACKAGE DIMENSIONS in inches (millimeters)



i178003

**OZONE DEPLETING SUBSTANCES POLICY STATEMENT**

It is the policy of Vishay Semiconductor GmbH to

1. Meet all present and future national and international statutory requirements.
2. Regularly and continuously improve the performance of our products, processes, distribution and operating systems with respect to their impact on the health and safety of our employees and the public, as well as their impact on the environment.

It is particular concern to control or eliminate releases of those substances into the atmosphere which are known as ozone depleting substances (ODSs).

The Montreal Protocol (1987) and its London Amendments (1990) intend to severely restrict the use of ODSs and forbid their use within the next ten years. Various national and international initiatives are pressing for an earlier ban on these substances.

Vishay Semiconductor GmbH has been able to use its policy of continuous improvements to eliminate the use of ODSs listed in the following documents.

1. Annex A, B and list of transitional substances of the Montreal Protocol and the London Amendments respectively.
2. Class I and II ozone depleting substances in the Clean Air Act Amendments of 1990 by the Environmental Protection Agency (EPA) in the USA
3. Council Decision 88/540/EEC and 91/690/EEC Annex A, B and C (transitional substances) respectively.

Vishay Semiconductor GmbH can certify that our semiconductors are not manufactured with ozone depleting substances and do not contain such substances.

We reserve the right to make changes to improve technical design  
and may do so without further notice.

Parameters can vary in different applications. All operating parameters must be validated for each customer application by the customer. Should the buyer use Vishay Semiconductors products for any unintended or unauthorized application, the buyer shall indemnify Vishay Semiconductors against all claims, costs, damages, and expenses, arising out of, directly or indirectly, any claim of personal damage, injury or death associated with such unintended or unauthorized use.

Vishay Semiconductor GmbH, P.O.B. 3535, D-74025 Heilbronn, Germany



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